



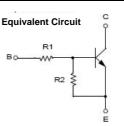
FJY3015R NPN Epitaxial Silicon Transistor

Features

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R1=2.2KΩ, R2=10KΩ)







Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	50	V
V _{CEO} Collector-Emitter Voltage		50	V
V _{EBO}	Emitter-Base Voltage	10	V
I _C	Collector Current	100	mA
T _{STG} Storage Temperature Range		-55~150	۵°
TJ	Junction Temperature	150	°C
P _C	P _C Collector Power Dissipation, by R _{0JA}		mW

These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

Thermal Characteristics* Ta=25°C unless otherwise noted

Symbol	Parameter	Мах	Units
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	N/A	°C/W

Minimum land pad.

Symbol

V(BR)CBO

Electrical Characteristics* T_C = 25°C unless otherwise noted

Parameter	Test Condition	MIN	Тур
Collector-Emitter Breakdown Voltage	$Ic = 10 \text{ uA}, I_E = 0$	50	
Collector-Base Breakdown Voltage	$Ic = 100 \text{ uA}, I_B = 0$	50	
Collector-Cutoff Current	$V_{CB} = 40 V$, $I_E = 0$		
DC Current Gain	Vce = 5 V, Ic = 10 mA	33	
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V V(BR)CEO Ісво 0.1 uA hee V VCE(sat) 0.3 Collector-Emitter Saturation Voltage Ic = 10 mA, I_B = 0.5 mA $V_{CE} = 10V, I_{C} = 5 \text{ mA}$ fт Current Gain - Bandwidth Product 250 MHz Ccb VCB = 10 V, IE = 0, f = 1.0 MHz **Output Capacitance** 3.7 pF $V_{CE} = 5 V, I_{C} = 100 uA$ 0.3 V VI(off) Input Off Voltage V $V_{CE} = 0.3V$, $I_{C} = 20mA$ VI(on) Input On Voltage 3 R1 Input Resistor 1.5 2.2 2.9 KΩ R1/R2 **Resistor Ratio** 0.20 0.22 0.25 * Pulse Test: PW≤300µs, Duty Cycle≤2%

MAX

Units

V

July 2007

Typical Performance Characteristics

Figure 1. DC current Gain

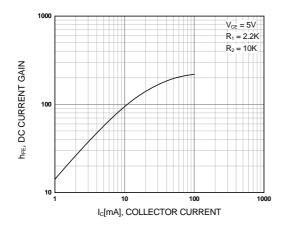


Figure 2. Input On Voltage

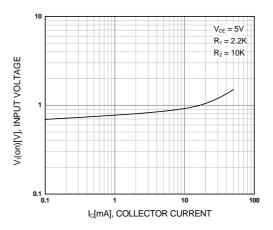


Figure 3. Input off Voltage

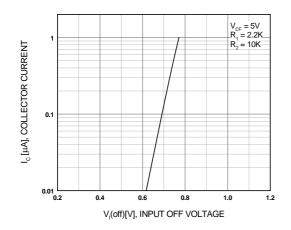
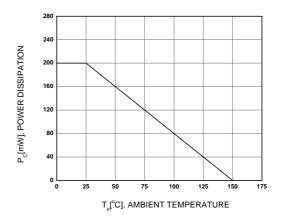
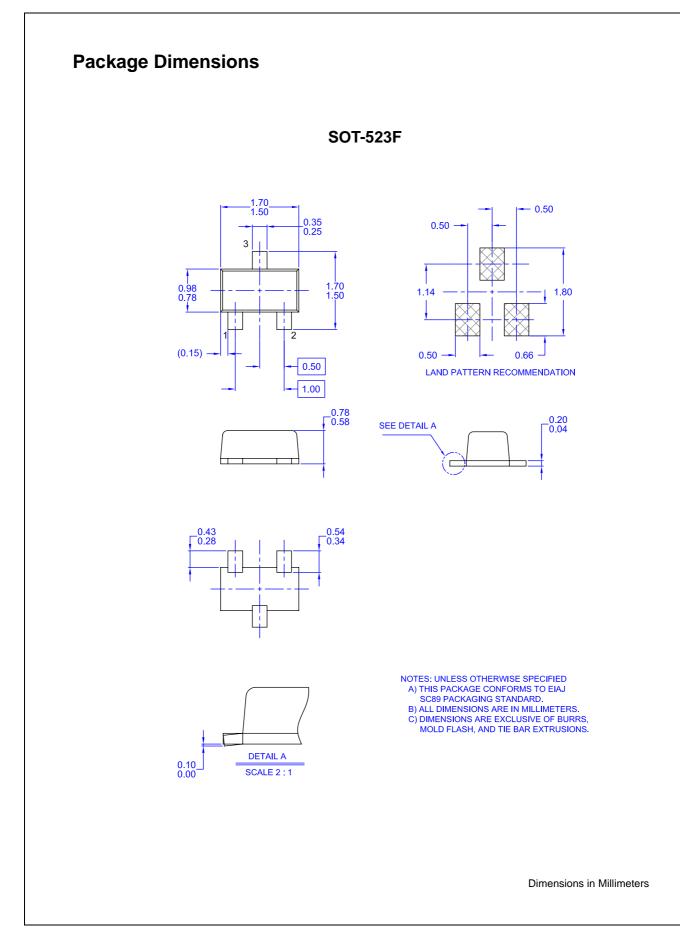


Figure 4. Power Derating





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